# 2SK3147L-VB Datasheet

## N-Channel 100-V (D-S) MOSFET

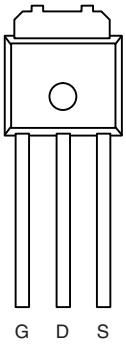
| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{DS}$ (V) | 100 | |
| $R_{DS(on)}$ (Ω) | $V_{GS}$ = 10 V | 0.20 |
| $Q_g$ (Max.) (nC) | 16 | |
| $Q_{gs}$ (nC) | 4.4 | |
| $Q_{gd}$ (nC) | 7.7 | |
| Configuration | Single | |

### FEATURES

- **Halogen-free According to IEC 61249-2-21 Definition**
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling

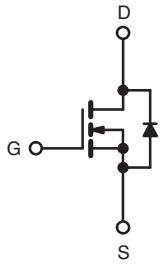
RoHS* Available
HALOGEN FREE Available

**TO-251**




Drain Connected to Drain-Tab

Top View

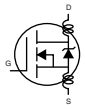



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_C$ = 25 °C, unless otherwise noted) | | | | | |
|---|---|---|---|---|---|
| **PARAMETER** | | | **SYMBOL** | **LIMIT** | **UNIT** |
| Drain-Source Voltage | | | $V_{DS}$ | 100 | V |
| Gate-Source Voltage | | | $V_{GS}$ | ± 20 | |
| Continuous Drain Current | $V_{GS}$ at 10 V | $T_C$ = 25 °C | $I_D$ | 12 | A |
| | | $T_C$ = 100 °C | | 7.5 | |
| Pulsed Drain Current[a] | | | $I_{DM}$ | 37 | |
| Linear Derating Factor | | | | 0.40 | W/°C |
| Linear Derating Factor (PCB Mount) | | | | 0.025 | |
| Single Pulse Avalanche Energy[b] | | | $E_{AS}$ | 200 | mJ |
| Avalanche Currenta | | | $I_{AR}$ | 9.2 | A |
| Repetitive Avalanche Energy[a] | | | $E_{AR}$ | 6.0 | mJ |
| Maximum Power Dissipation | $T_C$ = 25 °C | | $P_D$ | 60 | W |
| Maximum Power Dissipation (PCB Mount) | $T_A$ = 25 °C | | | 3.7 | |
| Peak Diode Recovery dV/dt[c] | | | dV/dt | 5.5 | V/ns |
| Operating Junction and Storage Temperature Range | | | $T_J$, $T_{stg}$ | - 55 to + 175 | °C |
| Soldering Recommendations (Peak Temperature) | For 10 s | | | 300[d] | |

**Notes**
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. $V_{DD}$ = 25 V, starting $T_J$ = 25 °C, L = 3.5 mH, $R_g$ = 25 Ω, $I_{AS}$ = 9.2 A (see fig. 12).
c. $I_{SD}$ ≤ 9.2 A, dI/dt ≤ 110 A/μs, $V_{DD}$ ≤ $V_{DS}$, $T_J$ ≤ 175 °C.

| THERMAL RESISTANCE RATINGS | | | | |
|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Maximum Junction-to-Ambient | $R_{thJA}$ | - | 62 | °C/W |
| Maximum Junction-to-Ambient (PCB Mount)[a] | $R_{thJA}$ | - | 40 | |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | - | 2.5 | |

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{DS}$ | $V_{GS}$ = 0, $I_D$ = 250 µA | | 100 | - | - | V |
| $V_{DS}$ Temperature Coefficient | $\Delta V_{DS}/T_J$ | Reference to 25 °C, $I_D$ = 1 mA | | - | 0.13 | - | V/°C |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | | 1.0 | - | 3.0 | V |
| Gate-Source Leakage | $I_{GSS}$ | $V_{GS}$ = ± 20 V | | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 100 V, $V_{GS}$ = 0 V | | - | - | 25 | µA |
| | | $V_{DS}$ = 80 V, $V_{GS}$ = 0 V, $T_J$ = 150 °C | | - | - | 250 | |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | $V_{GS}$ = 10 V | $I_D$ = 5.5 A[b] | - | 0.20 | - | Ω |
| Forward Transconductance | $g_{fs}$ | $V_{DS}$ = 50 V, $I_D$ = 5.5 A[b] | | 2.7 | - | - | S |
| **Dynamic** | | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1.0 MHz, see fig. 5 | | - | 360 | - | pF |
| Output Capacitance | $C_{oss}$ | | | - | 150 | - | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | - | 34 | - | |
| Total Gate Charge | $Q_g$ | $V_{GS}$ = 10 V | $I_D$ = 9.2 A, $V_{DS}$ = 80 V, see fig. 6 and 13[b] | - | - | 16 | nC |
| Gate-Source Charge | $Q_{gs}$ | | | - | - | 4.4 | |
| Gate-Drain Charge | $Q_{gd}$ | | | - | - | 7.7 | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}$ = 50 V, $I_D$ = 9.2 A, $R_g$ = 18 Ω, $R_D$ = 5.2 Ω, see fig. 10[b] | | - | 8.8 | - | ns |
| Rise Time | $t_r$ | | | - | 30 | - | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | - | 19 | - | |
| Fall Time | $t_f$ | | | - | 20 | - | |
| Internal Drain Inductance | $L_D$ | Between lead, 6 mm (0.25") from package and center of die contact  | | - | 4.5 | - | nH |
| Internal Source Inductance | $L_S$ | | | - | 7.5 | - | |
| **Drain-Source Body Diode Characteristics** | | | | | | | |
| Continuous Source-Drain Diode Current | $I_S$ | MOSFET symbol showing the integral reverse p - n junction diode  | | - | - | 9.2 | A |
| Pulsed Diode Forward Current[a] | $I_{SM}$ | | | - | - | 37 | |
| Body Diode Voltage | $V_{SD}$ | $T_J$ = 25 °C, $I_S$ = 9.2 A, $V_{GS}$ = 0 V[b] | | - | - | 1.8 | V |
| Body Diode Reverse Recovery Time | $t_{rr}$ | $T_J$ = 25 °C, $I_F$ = 9.2 A, dI/dt = 100 A/µs[b] | | - | 110 | 260 | ns |
| Body Diode Reverse Recovery Charge | $Q_{rr}$ | | | - | 0.53 | 1.3 | µC |
| Forward Turn-On Time | $t_{on}$ | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$) | | | | | |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

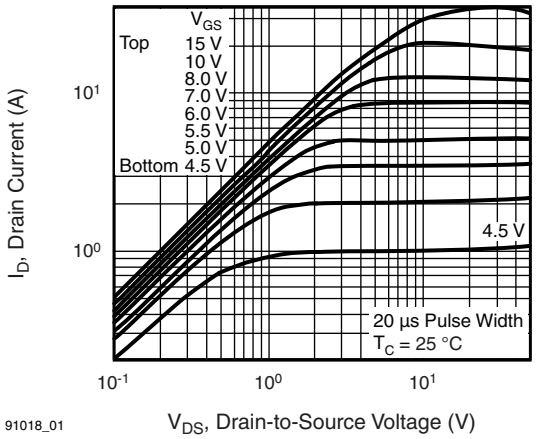



**Fig. 1 - Typical Output Characteristics, $T_C$ = 25 °C**

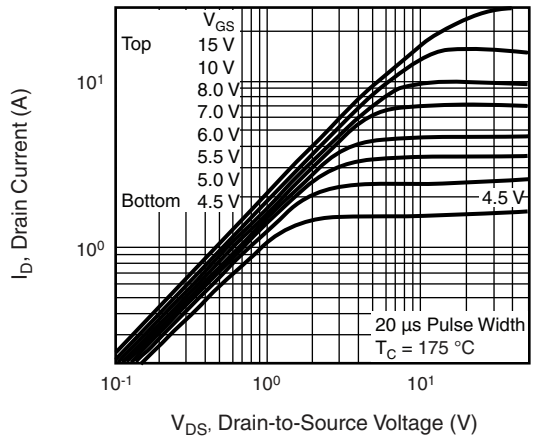



**Fig. 2 - Typical Output Characteristics, $T_C$ = 175 °C**

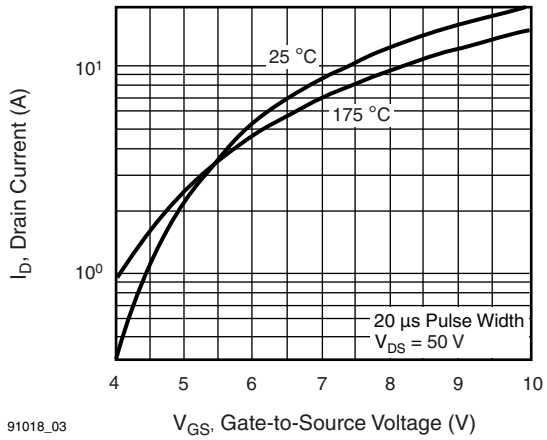



**Fig. 3 - Typical Transfer Characteristics**

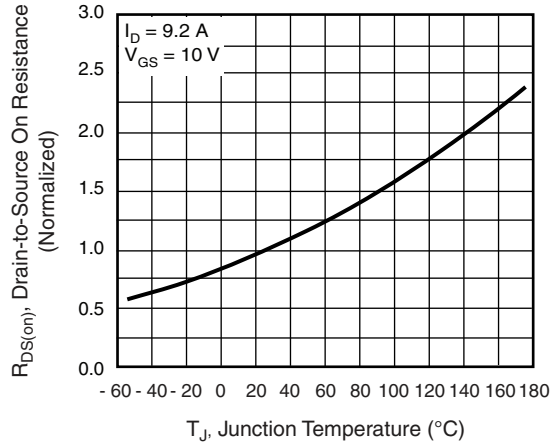



**Fig. 4 - Normalized On-Resistance vs. Temperature**

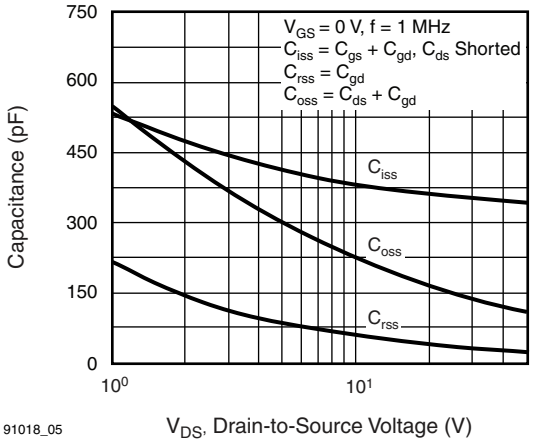



**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

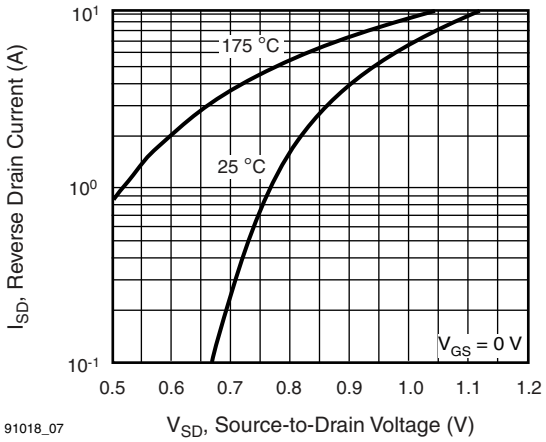



**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

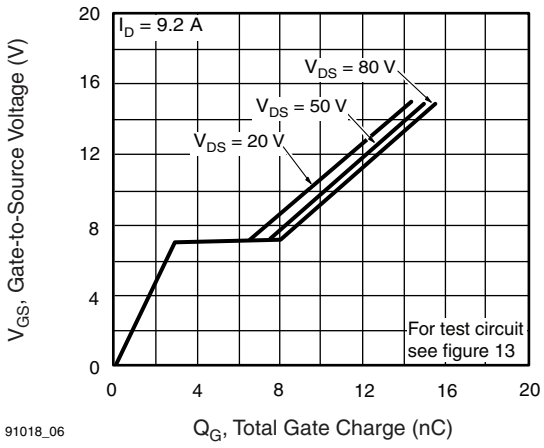



**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**

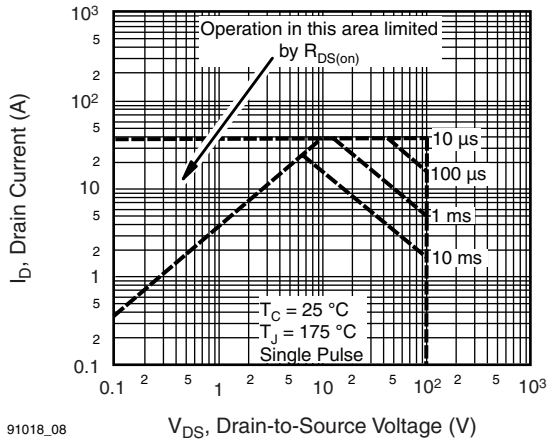



**Fig. 8 - Maximum Safe Operating Area**

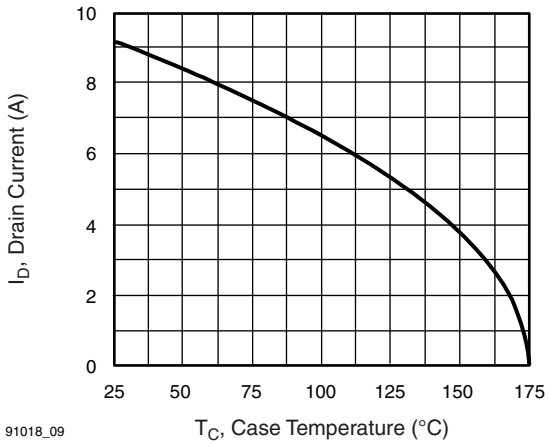



**Fig. 9 - Maximum Drain Current vs. Case Temperature**

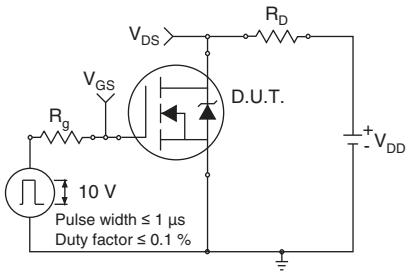



**Fig. 10a - Switching Time Test Circuit**

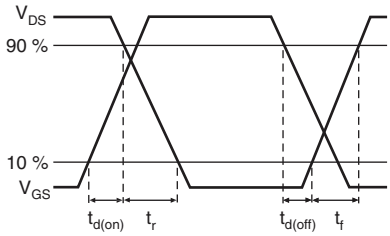



**Fig. 10b - Switching Time Waveforms**

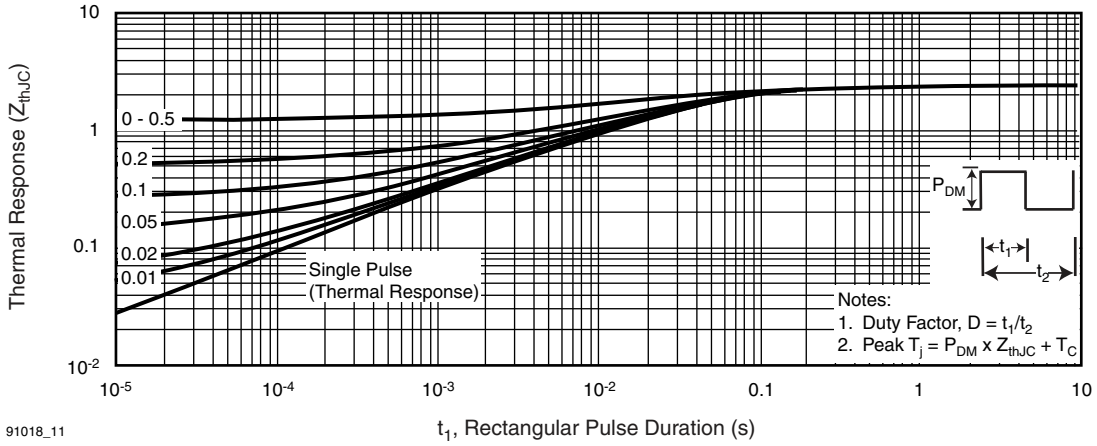



**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

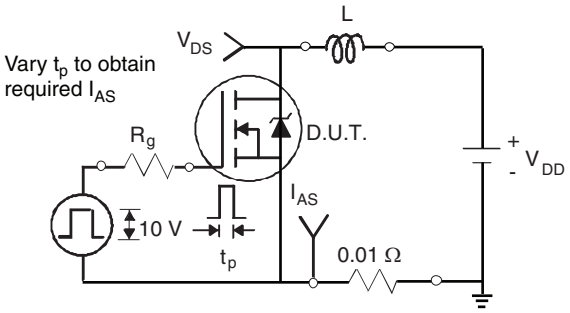



**Fig. 12a - Unclamped Inductive Test Circuit**

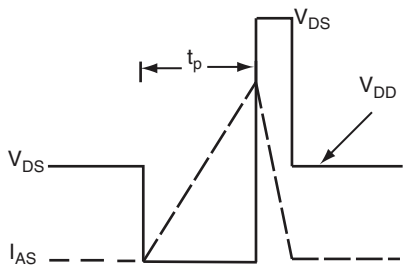



**Fig. 12b - Unclamped Inductive Waveforms**

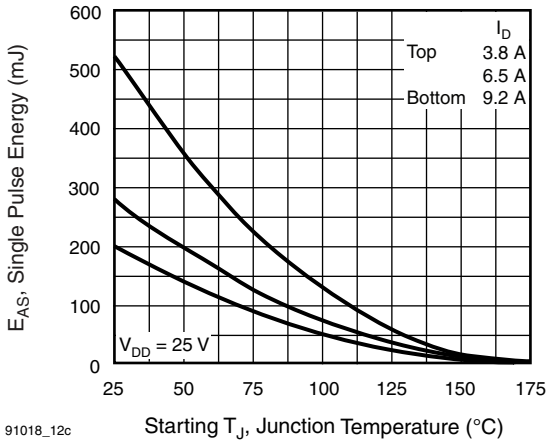



**Fig. 12c - Maximum Avalanche Energy vs. Drain Current**

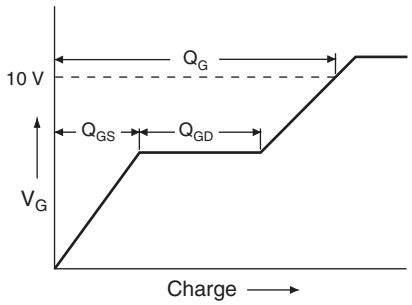



**Fig. 13a - Basic Gate Charge Waveform**

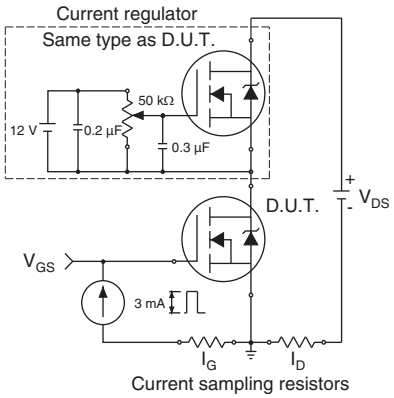
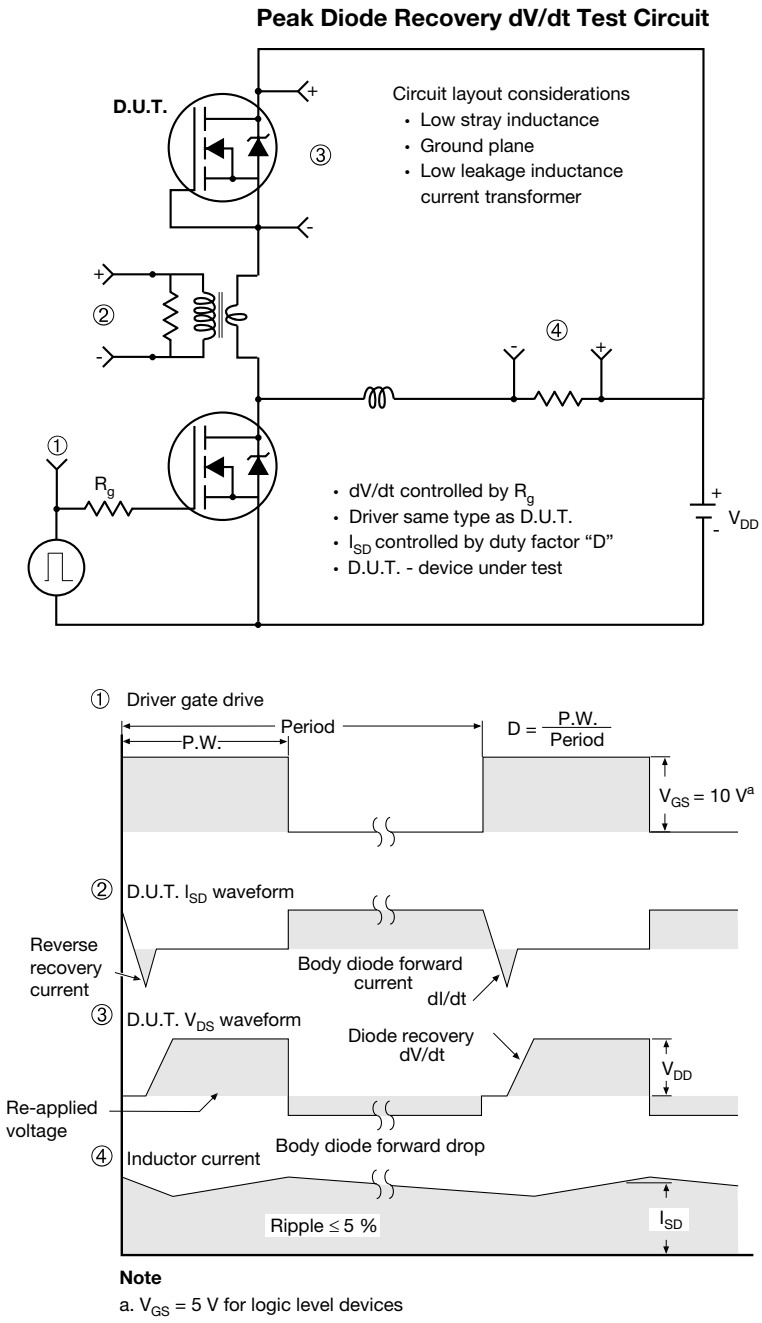



**Fig. 13b - Gate Charge Test Circuit**

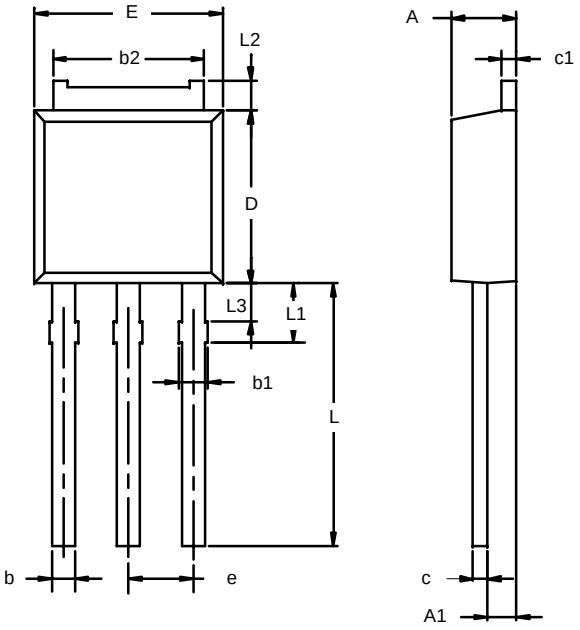



**Note**

a. $V_{GS}$ = 5 V for logic level devices

**Fig. 14 - For N-Channel**

## TO-251AA




| Dim | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| | Min | Max | Min | Max |
| A | 2.21 | 2.38 | 0.087 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.71 | 0.89 | 0.028 | 0.035 |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 |
| c | 0.46 | 0.58 | 0.018 | 0.023 |
| c1 | 0.46 | 0.58 | 0.018 | 0.023 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| E | 6.48 | 6.73 | 0.255 | 0.265 |
| e | 2.28 BSC | | 0.090 BSC | |
| L | 3.89 | 9.53 | 0.153 | 0.375 |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 |

Note: Dimension L3 is for reference only.

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